



RFM products are now Murata products.

SF1141B-4

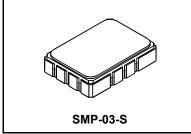
- · Designed for SDARS IF Receiver
- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- · Differential Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

7 100 0 1 100 10 100 100 100 100 100 100		
Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	





#### **Electrical Characteristics**

Characteristic			Notes	Min	Тур	Max	Units
Nominal Center Frequency		f <sub>C</sub>	1	75.000			MHz
Passband	Insertion Loss at fc	IL	'		12.5	16.0	dB
	1dB Passband	BW <sub>1</sub>		±6.35	±7.43		MHz
	Fast Amplitude Ripple over fc ±6.35 MHz		1, 2			1.5	dB <sub>P-P</sub>
Group Delay Variation over fc ±6.35 MHz					75	200	ns <sub>P-P</sub>
Rejection	fc-100 to fc-18.8 MHz		1, 2, 3	40	45		dB
	fc-18.8 to fc-10.95 MHz			37	45		
	fc+10.95 to fc+18.8 MHz			30	36		
	fc+18.8 to fc+100 MHz			40	45		
Operating Temperature Range		T <sub>A</sub>	1	-40		+85	°C
Differential Input and Output Impedance		250 ohms					
Case Style		SMP-03-S 7 x 5 mm Nominal Footpr			tprint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			6	RFM SF1141B-4 YYWWS			

#### **Electrical Connections**

Connection	Port 1 Hot	Port 1 Ground Return or Hot	Port 2 Hot	Port 2 Ground Return or Hot	Case Ground
Terminals	10	1	5	6	All Others

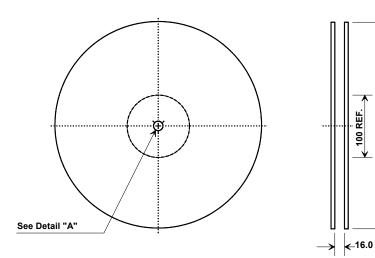


### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

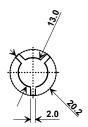
#### NOTES:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to  $50 \Omega$  and measured with  $50 \Omega$  network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply.

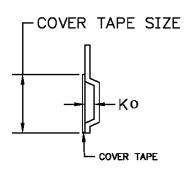
# **Tape and Reel Specifications**



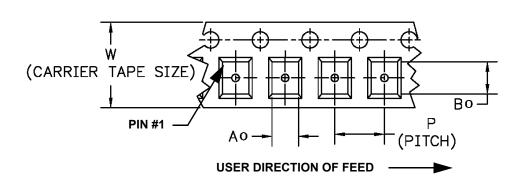
"B " Nominal Size		Quantity Per Reel		
Inches	millimeters			
7	178	500		
13	330	2000		



# **COMPONENT ORIENTATION and DIMENSIONS**

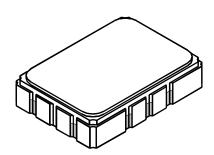


Carrier Tape Dimens	Carrier Tape Dimensions		
Ao	5.5 mm	± 0.1mm	
Во	7.5 mm	± 0.1mm	
Ко	2.0 mm	± 0.1mm	
Pitch	8.0 mm	± 0.1mm	
W	16.0 mm	± 0.2mm	



# SMP-03-S Case 💫

# 12-Terminal Ceramic Surface-Mount Case 5 x 7 mm Nominal Footprint



Case Dimensions						
Dimension	mm		Inches			
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D		0.80				
E	2.41	2.54	2.67	0.095	0.100	0.105
Н	0.87	1.1	1.13	0.034	0.039	0.044
J		2.54				
K	2.87	3.00	3.13	0.113	0.118	0.123
Р	1.14	1.27	1.40	0.045	0.050	0.055

Materials			
Solder Pad	Au plating 30 - 60 μinches (76.2-152 μm) over 80-		
Termination	200 μinches (203-508 μm) Ni.		
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phos-		
	phorus) 100-200 µinches Thick		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
Pb Free			

